

**TOSHIBA**

**2SK2866**

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE ( $\pi$ -MOS V)

# 2SK2866

HIGH SPEED, HIGH CURRENT SWITCHING APPLICATIONS

CHOPPER REGULATORS, DC-DC CONVERTER AND MOTOR DRIVE APPLICATIONS

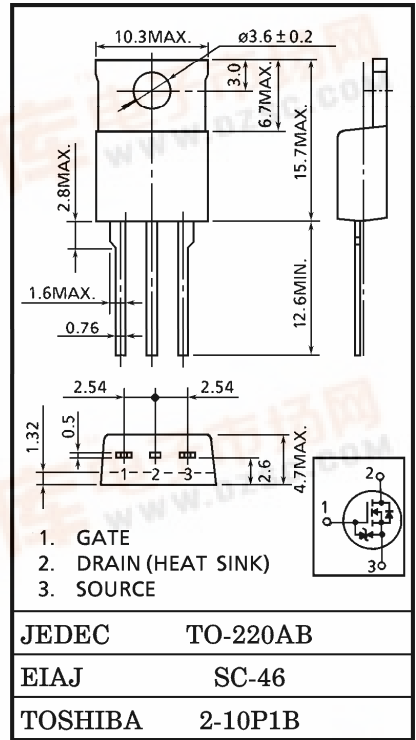
INDUSTRIAL APPLICATIONS

Unit in mm

- Low Drain-Source ON Resistance :  $R_{DS(ON)} = 0.54 \Omega$  (Typ.)
- High Forward Transfer Admittance :  $|Y_{fs}| = 9.0 S$  (Typ.)
- Low Leakage Current :  $I_{DSS} = 100 \mu A$  (Max.) ( $V_{DS} = 600 V$ )
- Enhancement-Mode :  $V_{th} = 2.0 \sim 4.0 V$   
( $V_{DS} = 10 V, I_D = 1 mA$ )

MAXIMUM RATINGS ( $T_a = 25^\circ C$ )

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		$V_{DSS}$	600	V
Drain-Gate Voltage ( $R_{GS} = 20 k\Omega$ )		$V_{DGR}$	600	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Drain Current	DC	$I_D$	10	A
	Pulse	$I_{DP}$	40	A
Drain Power Dissipation ( $T_c = 25^\circ C$ )		$P_D$	125	W
Single Pulse Avalanche Energy**		$E_{AS}$	363	mJ
Avalanche Current		$I_{AR}$	10	A
Repetitive Avalanche Energy*		$E_{AR}$	12.5	mJ
Channel Temperature		$T_{ch}$	150	$^\circ C$
Storage Temperature Range		$T_{stg}$	$-55 \sim 150$	$^\circ C$



Weight : 1.9 g (Typ.)

THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	$R_{th(ch-c)}$	1.0	$^\circ C / W$
Thermal Resistance, Channel to Ambient	$R_{th(ch-a)}$	83.3	$^\circ C / W$

Note ;

\* Repetitive rating ; Pulse Width Limited by Max. junction temperature.

\*\*  $V_{DD} = 90 V, T_{ch} = 25^\circ C, L = 6.36 mH, R_G = 25 \Omega, I_{AR} = 10 A$

**This transistor is an electrostatic sensitive device.  
Please handle with caution.**

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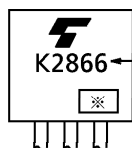
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		$I_{GSS}$	$V_{GS} = \pm 25\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Gate-Source Breakdown Voltage		$V(\text{BR})_{GSS}$	$I_G = \pm 10\ \mu\text{A}, V_{DS} = 0\text{ V}$	$\pm 30$	—	—	V
Drain Cut-off Current		$I_{DSS}$	$V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}$	—	—	100	$\mu\text{A}$
Drain-Source Breakdown Voltage		$V(\text{BR})_{DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	600	—	—	V
Gate Threshold Voltage		$V_{th}$	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	2.0	—	4.0	V
Drain-Source ON Resistance		$R_{DS(\text{ON})}$	$V_{GS} = 10\text{ V}, I_D = 5\text{ A}$	—	0.54	0.75	$\Omega$
Forward Transfer Admittance		$ Y_{fs} $	$V_{DS} = 10\text{ V}, I_D = 5\text{ A}$	3.0	9.0	—	S
Input Capacitance		$C_{iss}$	$V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	2040	—	pF
Reverse Transfer Capacitance		$C_{rss}$		—	210	—	
Output Capacitance		$C_{oss}$		—	630	—	
Switching Time	Rise Time	$t_r$	<p><math>I_D = 5\text{ A}</math>  <math>V_{GS} = 10\text{ V}</math>  <math>V_{OUT}</math>  <math>R_L = 40\ \Omega</math>  <math>V_{DD} \approx 200\text{ V}</math></p>	—	22	—	ns
	Turn-on Time	$t_{on}$		—	58	—	
	Fall Time	$t_f$		—	36	—	
	Turn-off Time	$t_{off}$		$V_{IN} : t_r, t_f < 5\text{ ns},$ $\text{Duty} \leq 1\%, t_w = 10\ \mu\text{s}$	—	190	
Total Gate Charge (Gate-Source Plus Gate-Drain)		$Q_g$	$V_{DD} \approx 400\text{ V}, V_{GS} = 10\text{ V}, I_D = 10\text{ A}$	—	45	—	nC
Gate-Source Charge		$Q_{gs}$		—	25	—	
Gate-Drain (“Miller”) Charge		$Q_{gd}$		—	20	—	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	$I_{DR}$	—	—	—	10	A
Pulse Drain Reverse Current	$I_{DRP}$	—	—	—	40	A
Diode Forward Voltage	$V_{DSF}$	$I_{DR} = 10\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.7	V
Reverse Recovery Time	$t_{rr}$	$I_{DR} = 10\text{ A}, V_{GS} = 0\text{ V}$	—	1300	—	ns
Reverse Recovery Charge	$Q_{rr}$	$dI_{DR}/dt = 100\text{ A}/\mu\text{s}$	—	16	—	$\mu\text{C}$

MARKING

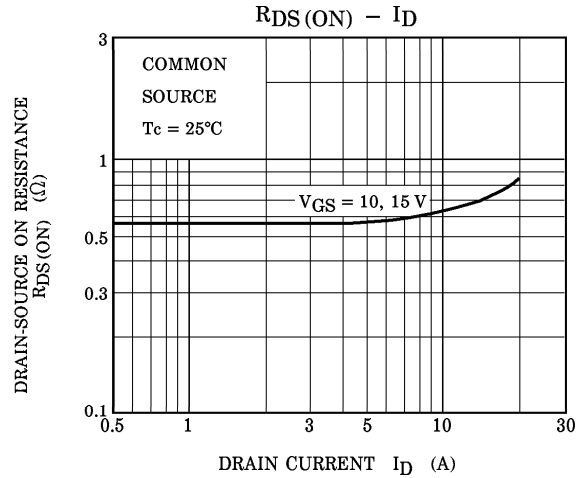
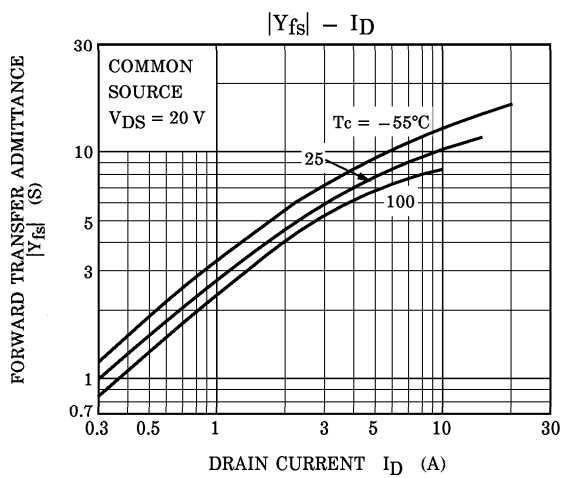
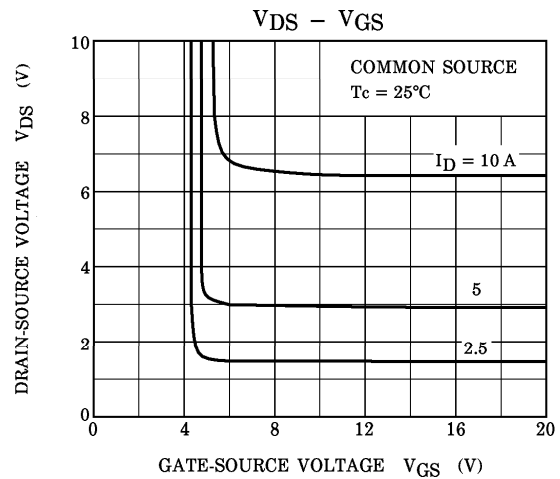
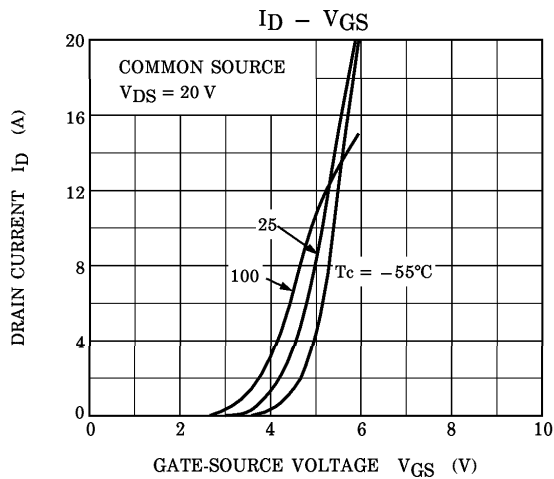
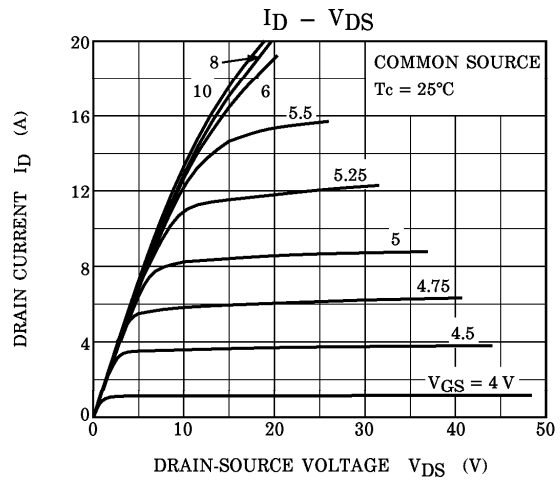
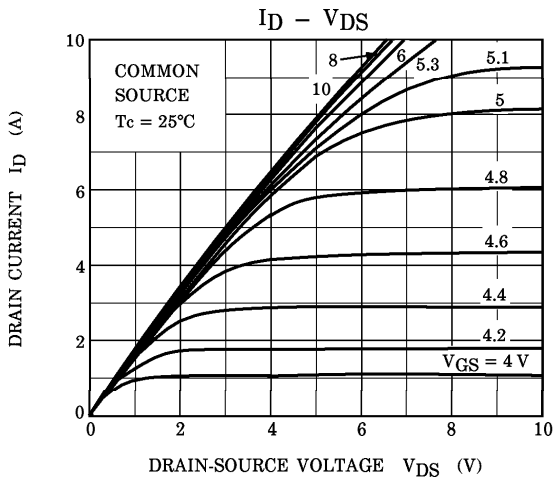


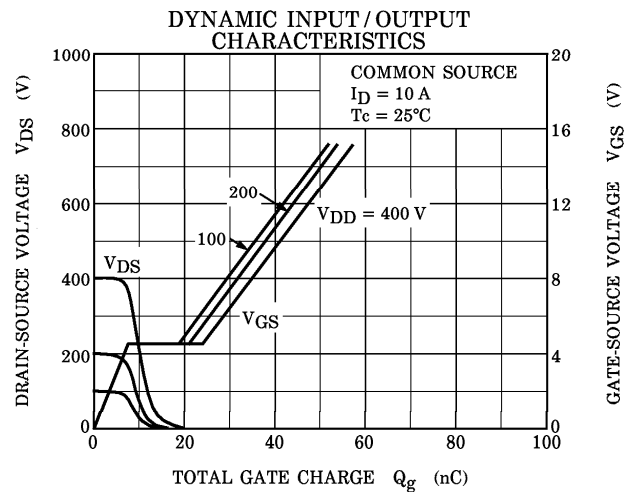
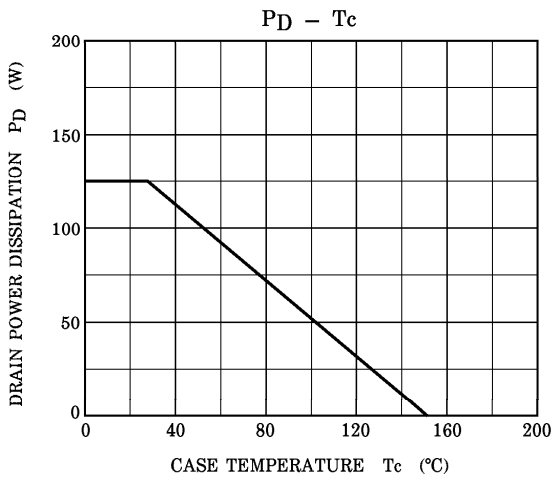
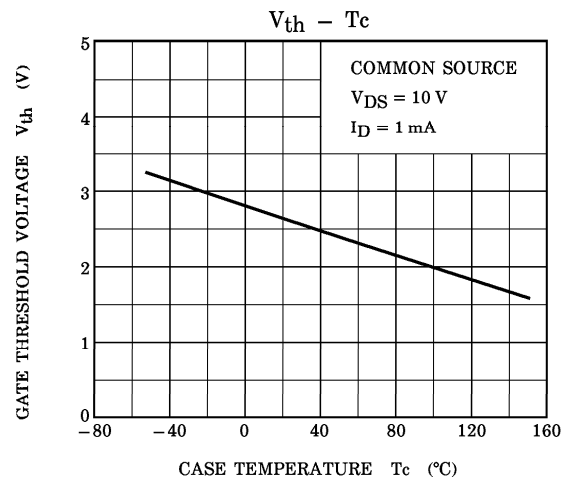
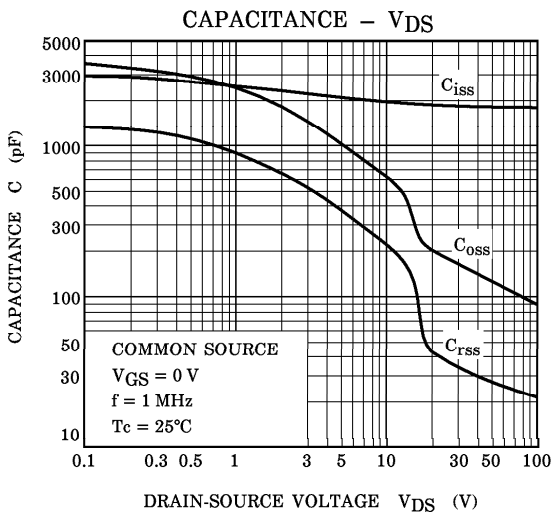
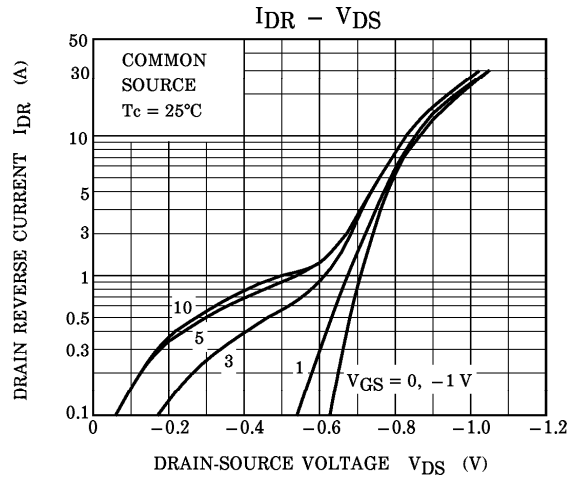
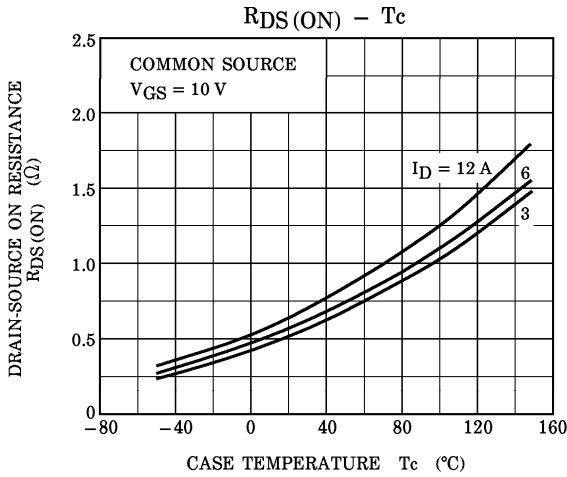
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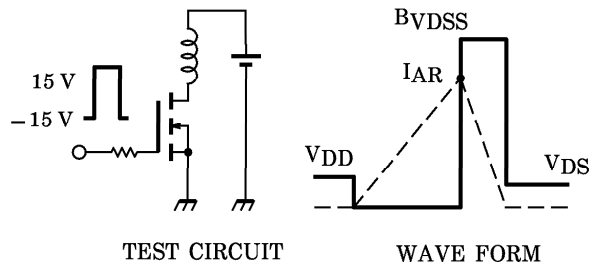
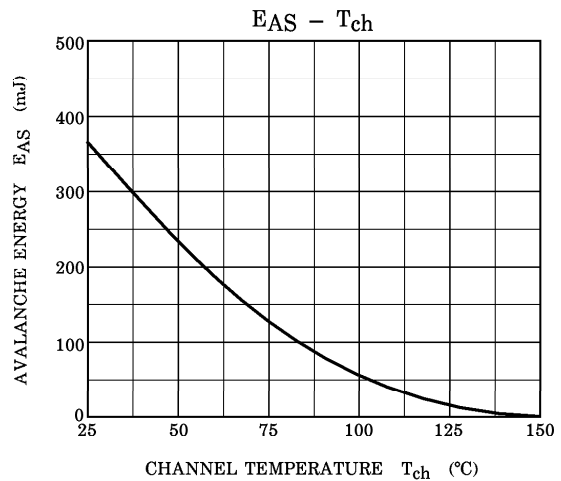
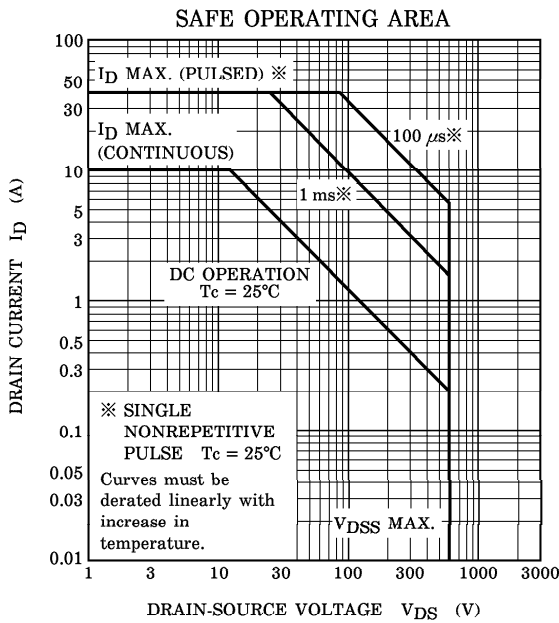
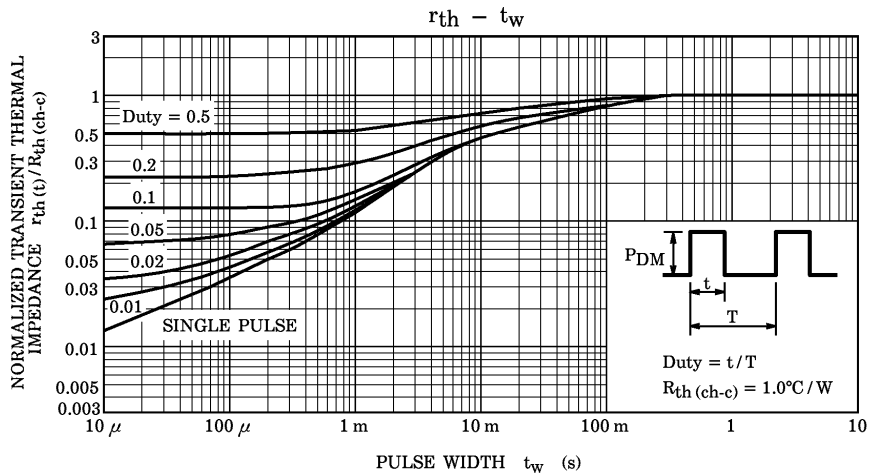
※ Lot Number

□ □ — Month (Starting from Alphabet A)

— Year (Last Number of the Christian Era)







Peak  $I_{AR} = 10$  A,  $R_G = 25 \Omega$   
 $V_{DD} = 90$  V,  $L = 6.36$  mH

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$